

ASPI-1367-3R3M-T Datasheet



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DiGi Electronics Part Number	ASPI-1367-3R3M-T-DG
Manufacturer	Abracon LLC
Manufacturer Product Number	ASPI-1367-3R3M-T
Description	FIXED IND 3.3UH 15A 6.8 MOHM SMD
Detailed Description	3.3 μ H Shielded Drum Core, Wirewound Inductor 15 A 6.8mOhm Max Nonstandard



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DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

ASPI-1367-3R3M-T

Series:

ASPI-1367

Type:

Drum Core, Wirewound

Inductance:

3.3 μ H

Current Rating (Amps):

15 A

Shielding:

Shielded

Q @ Freq:

-

Ratings:

-

Inductance Frequency - Test:

200 kHz

Package / Case:

Nonstandard

Size / Dimension:

0.551" L x 0.508" W (14.00mm x 12.90mm)

Manufacturer:

Abracon LLC

Product Status:

Active

Material - Core:

Ferrite

Tolerance:

\pm 20%

Current - Saturation (Isat):

29A

DC Resistance (DCR):

6.8mOhm Max

Frequency - Self Resonant:

-

Operating Temperature:

-40°C ~ 125°C

Mounting Type:

Surface Mount

Supplier Device Package:

-

Height - Seated (Max):

0.264" (6.70mm)

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8504.50.4000

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99

Shielded SMD Chip Power Inductor



ASPI-1367


14.0 x 12.9 x 6.7mm
RoHS/RoHS Compliant

Features

- 100%lead (Pb) free.
- Lowest DCR/ μ H, in this package size.
- Frequency range up to 5.0 MHz
- Handles high transient current spikes without saturation
- Ultra low buzz noise, due to composite construction

Applications

- PDA/notebook/desktop/server applications
- Low profile, high current power supply
- Battery powered devices
- DC/DC converter for Field Programmable Gate Array (FPGA)

Electrical Specifications

Operating Temperature:	-40°C to +125°C
Storage Temperature:	Less than +40°C, 70% RH

Part Number ASPI-1367-	L	Tolerance	R_{DC} (m Ω)	R_{DC} (m Ω)	I_{sat}	I_{rms}	Lead Type*
	(μ H)	(M)	Typ	Max	(A)	(A)	
R15	0.15	M	0.49	0.60	118.0	55.0	NLF
R22	0.22	M	0.47	0.60	112.0	53.0	NLF
R33	0.33	M	0.65	0.80	68.0	46.0	NLF
R47	0.47	M	0.90	1.20	63.0	41.0	NLF
R56	0.56	M	1.05	1.20	58.0	37.0	NLF
R68	0.68	M	1.25	1.50	55.0	35.0	NLF
1R0	1.00	M	1.70	2.30	48.0	30.0	NLF
1R5	1.50	M	2.50	3.00	45.0	27.0	NLF
2R2	2.20	M	3.80	4.00	37.0	22.0	LF
3R3	3.30	M	5.70	6.80	30.0	18.0	LF
4R7	4.70	M	7.00	8.40	28.0	13.5	LF
5R6	5.60	M	8.50	10.0	23.0	12.5	LF
6R8	6.80	M	9.50	11.5	18.0	11.5	LF
8R2	8.20	M	12.0	15.5	16.0	10.5	LF
100	10.0	M	13.2	16.5	15.5	10.0	LF
150	15.0	M	23.2	28	13.0	9.0	LF
220	22.0	M	32.5	37	12.0	9.0	LF
330	33.0	M	48	58	11.0	8.0	LF
470	47.0	M	76	90	9.5	6.5	LF
680	68.0	M	110	130	7.8	4.8	LF
101	100	M	145	165	5.5	4.2	LF

*Lead Type: NLF=Non-Leadframe, LF=Leadframe

Shielded SMD Chip Power Inductor



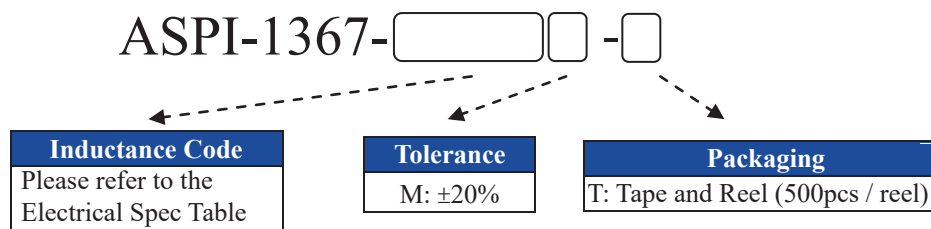
ASPI-1367


14.0 x 12.9 x 6.7mm
 RoHS/RoHS Compliant

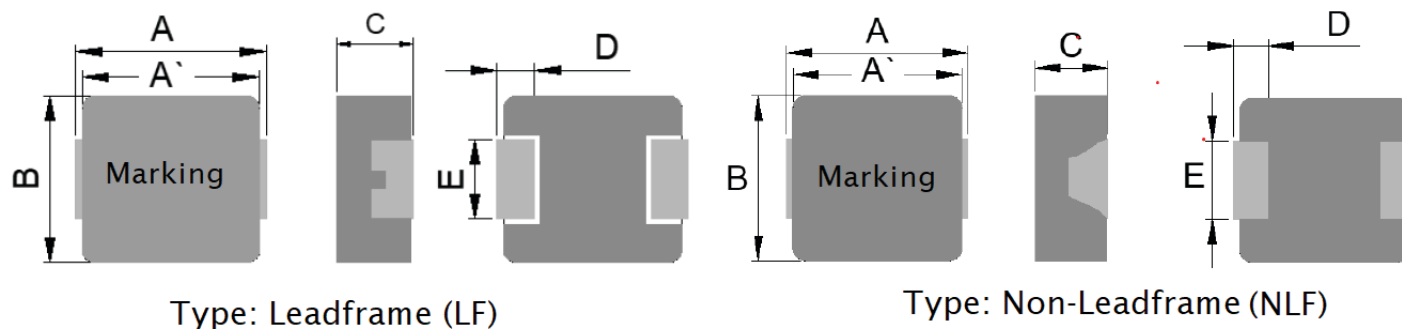
Test Conditions

1. Inductance tested at 200kHz, 0.25V, 0A; Tolerance $M=\pm 20\%$
2. All test data is in reference to 25°C ambient.
3. Isat will cause the inductance value to drop approximately 30%
4. Irms will cause an approximate ΔT of 40°C
5. The part temperature (ambient + temp. rise) should not exceed 125°C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
6. Please contact Abracon for the availability of other inductance values.

Part Number Identification



Mechanical Information



A	A'	B	C	D	E
13.5 ±0.5	12.5 ±0.3	12.50 ±0.50	6.20 ±0.30	2.30 ±0.3	4.70 ±0.3

Dimensions: mm

Shielded SMD Chip Power Inductor



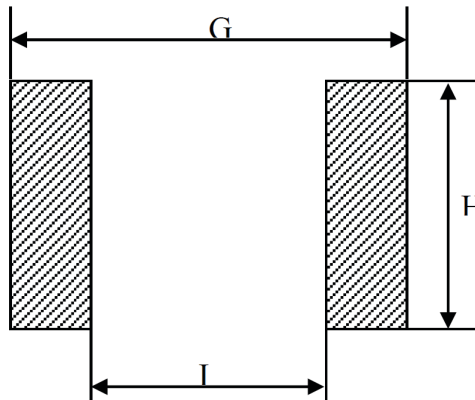
ASPI-1367



14.0 x 12.9 x 6.7mm
RoHS/RoHS Compliant

Mechanical Dimensions Cont.

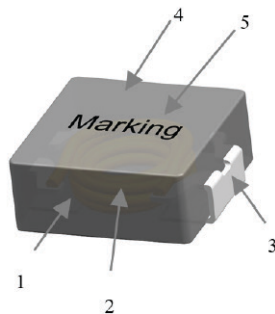
Recommended Land Pattern



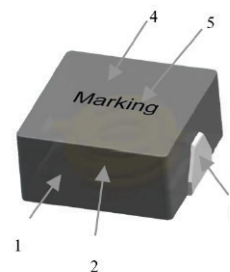
G	H	T
14.2 ref.	5.0 ref.	8.0 ref.

Dimensions: mm

Composition and Materials



Type: Leadframe



Type: Non-Leadframe

#	Material
1	Core
2	Wire
3	Leadframe: Clip
	Non-Leadframe: Solder Tab
4	Paint
5	Ink

Shielded SMD Chip Power Inductor

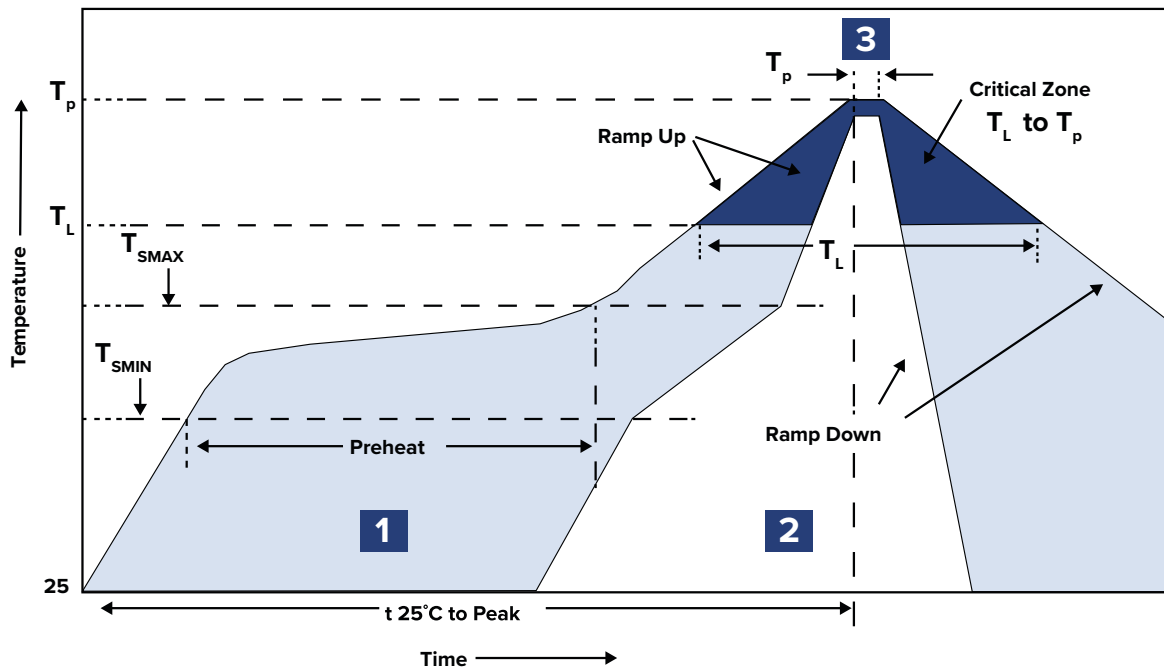
ASPI



ASPI-1367

14.0 x 12.9 x 6.7mm
RoHS/RoHS Compliant

Reflow Profile



Zone	Description	Temperature	Time
1	Preheat / Soak	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 200°C	60 ~ 180 sec.
2	Reflow	T_L 217°C	60 ~ 150 sec.
3	Peak heat	T_P 260°C	10 sec. MAX

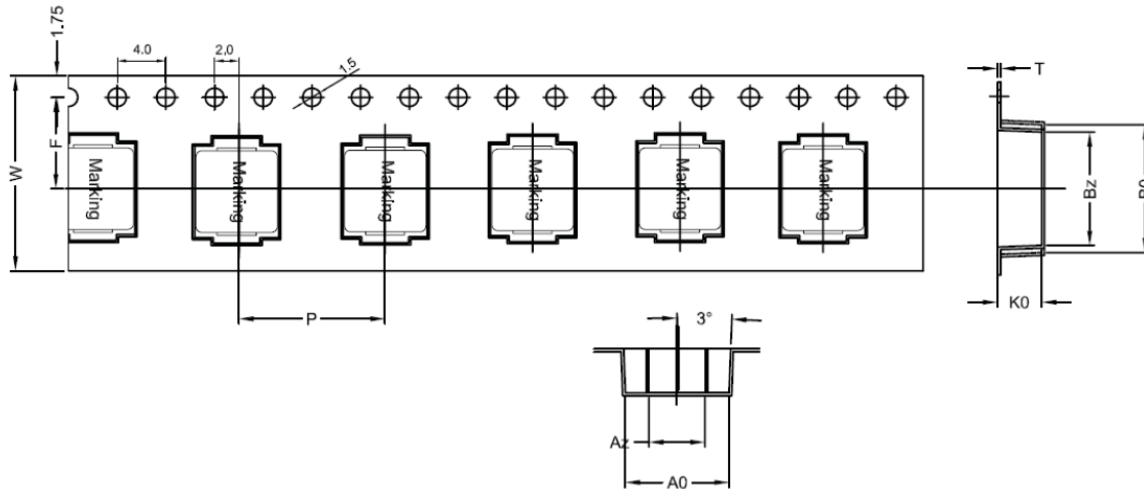
Shielded SMD Chip Power Inductor



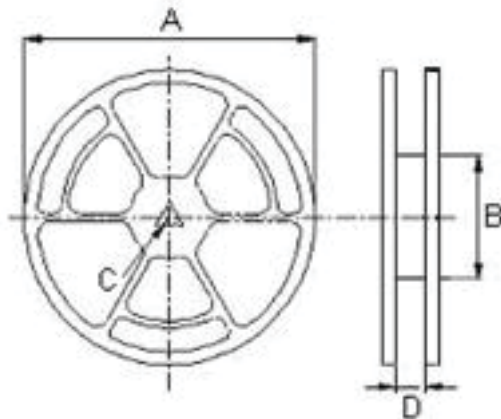
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Packaging

T= Tape and Reel (500pcs/reel)


B_0	B_Z	A_0	A_Z	K_0	P	W	F	T
14.1±0.1	13.0±0.1	12.9±0.1	7.0±0.1	7.0±0.1	16.0±0.1	24±0.3	11.5±0.1	0.35±0.05



A	B	C	D
330	100 ±2	13.0 +0.5/-0.2	24.4 +2/-0

Dimensions: mm

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